

ATTORNEY'S DOCKET NO.
TI-33824
(032350.B550)

PATENT APPLICATION

2012 U.S.PTO
123103

19270 U.S.PTO
10/749277

123103

1

TRANSMITTAL FOR U.S. PATENT APPLICATION
UNDER 37 CFR §1.53(b)

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing is the original patent application of:

Inventor: Rabah Mezenner

For: IMPROVED VIA ADHESION IN MULTILAYER MEMS STRUCTURE

Enclosed are:

Specification, Claims and Abstract (20 Pages);

Drawing(s) 4 Total Sheet(s) of Formal Informal);

Combined Declaration and Power of Attorney (1 Page)
 Newly executed (original or copy);

An Assignment (Page) of the invention to Texas Instruments Incorporated is attached. A separate cover sheet (Page) in compliance with 37 C.F.R. § 3.28 and § 3.31 is included. Please charge the Assignment recordal fee of \$40.00 pursuant to 37 C.F.R. § 1.21(h) to Deposit Account No. 20-0668 of Texas Instruments Incorporated;

Certificate of Mailing (1 Page);

TI Return Receipt Postcard (1);

Baker Botts Return Receipt Postcard (1); and

This Transmittal (2 pages).

Information Disclosure Statement (Page)
with PTO 1449 (Page) with references

Applicant is:

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TI-33824
(032350.B550)

PATENT APPLICATION

2

Large Entity
 Small Entity

The accompanying application is:

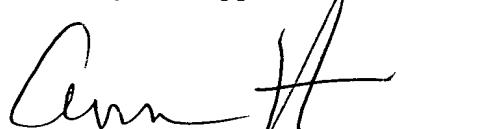
Original.

Continuation Divisional Continuation-In-Part (CIP) of prior application No.
which is hereby incorporated by reference therein.

FEE CALCULATION					FEE
	Number		Number Extra	Rate	Basic Fee
Total Claims	16	20	0	X \$18.00 =	\$.00
Independent Claims	4	3	1	X \$86.00 =	\$ 86.00
TOTAL FILING FEE =					\$ 856.00

Please charge the filing fee of \$856.00 and any other fee required by this paper, or credit any overpayment, to Deposit Account No. 20-0668 of TEXAS INSTRUMENTS INCORPORATED. **This document is being transmitted in duplicate.**

BAKER BOTTS L.L.P.
Attorneys for Applicants



Ann C. Livingston
Registration No 32,479

Date: 12/31/03

Correspondence Address:

Customer Number

23494

ATTORNEY DOCKET
TI-33824

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Rabah Mezenner

Date Filed: December 31, 2003

Title: IMPROVED VIA ADHESION IN MULTILAYER MEMS
STRUCTURE

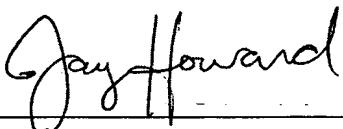
Mail Stop Patent Application

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Alexandria, Virginia 22313-1450

Dear Sir:

CERTIFICATE OF MAILING BY EXPRESS MAIL

I hereby certify that the attached Filing Fee Transmittal (2 pages), the Patent Application (20 pages), Formal Drawings (4 pages), a Baker Botts L.L.P. return receipt postcard (1 card), a Texas Instruments Incorporated return receipt postcard (1 card), and this Certificate of Mailing are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. § 1.10 and are addressed to the Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.



Jay Howard

Date: December 31, 2003

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